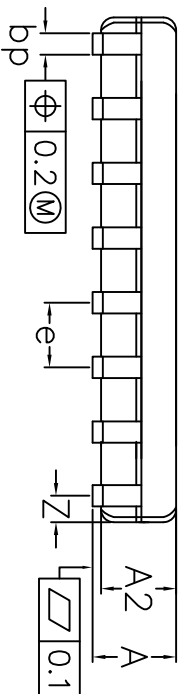
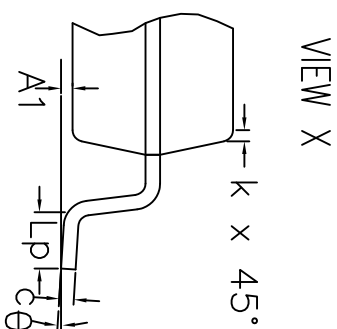
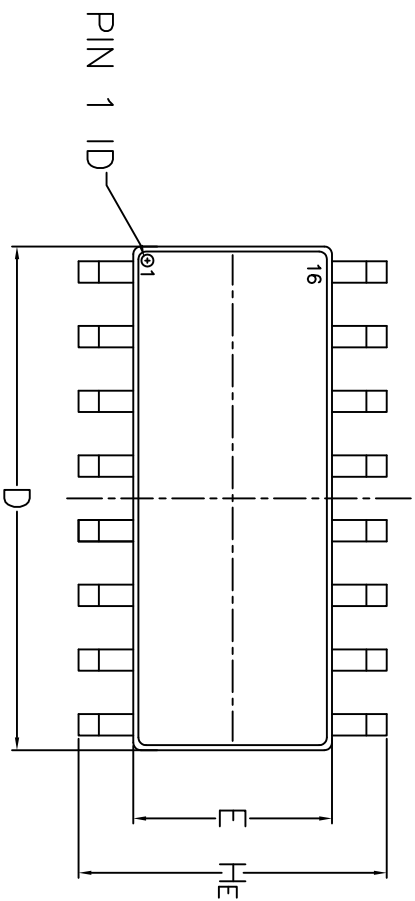


REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	2/24/16	J.H




DIMENSIONS OF SUB-GROUP B1	
A max	1.73
bp min	0.35
bp max	0.49
e nom	1.27
He min	5.80
He max	6.30
Lpmin	0.40
Z max	0.55

DIMENSIONS OF SUB-GROUP C1	
A min	1.55
A1 min	0.127
A1 max	0.25
A2 min	1.40
A2 max	1.55
c min	0.19
c max	0.25
D min*	9.80
D max*	9.98
E min*	3.80
E max*	4.00
k min	0.25
theta max	0°
theta max	8°

2. WEIGHT  $\leq 0.5$  g
3. BODY MATERIAL LOW STRESS EPOXY
4. LEAD MATERIAL FeNi-ALLOY or Cu-ALLOY
5. LEAD FINISH SOLDER PLATING
6. LEAD FORM Z-BENDS

\* WITHOUT MOLD FLASH

TOLERANCES UNLESS SPECIFIED			
DECIMAL	ANGULAR	8024 Silver Creek Valley Rd San Jose, CA 95138 PHONE: (408) 284-8200 FAX: (408) 284-3572	
xxx±	±	www.IDT.com	
xxxx±		TITLE DCG16 PACKAGE OUTLINE	
APPROVALS	DATE	150 mil SOP	
DRAWN	DATE	SIZE C	
CHECKED		DRAWING No. PSC-4068-02	
		DO NOT SCALE DRAWING	
		SHEET 1 OF 1	